

# MC74HC112A

## Dual J-K Flip-Flop with Set and Reset

### High-Performance Silicon-Gate CMOS

The MC74HC112A is identical in pinout to the LS112. The device inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LSTTL outputs.

Each flip-flop is negative-edge clocked and has active-low asynchronous Set and Reset inputs.

The HC112A is identical in function to the HC76, but has a different pinout.

#### Features

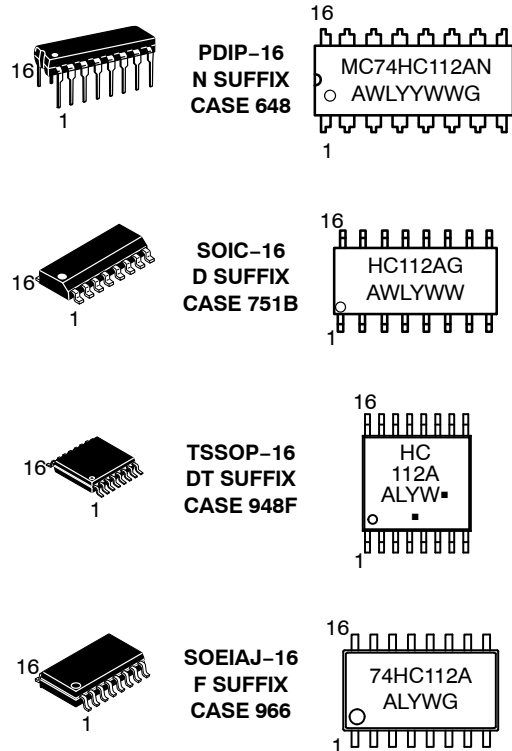
- Output Drive Capability: 10 LSTTL Loads
- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 2.0 to 6.0 V
- Low Input Current: 1.0  $\mu$ A
- High Noise Immunity Characteristic of CMOS Devices
- In Compliance with the Requirements Defined by JEDEC Standard No. 7A
- Similar in Function to the LS112 Except When Set and Reset are Low Simultaneously
- Chip Complexity: 100 FETs or 25 Equivalent Gates
- Pb-Free Packages are Available\*



ON Semiconductor®

<http://onsemi.com>

#### MARKING DIAGRAMS



A = Assembly Location  
L, WL = Wafer Lot  
Y, YY = Year  
W, WW = Work Week  
G = Pb-Free Package  
▪ = Pb-Free Package  
(Note: Microdot may be in either location)

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# MC74HC112A

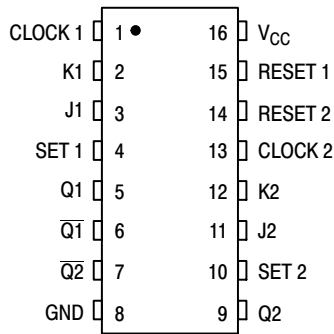


Figure 1. Pin Assignment

## FUNCTION TABLE

| Inputs |       |       |   |   | Outputs   |    |
|--------|-------|-------|---|---|-----------|----|
| Set    | Reset | Clock | J | K | Q         | Q̄ |
| L      | H     | X     | X | X | H         | L  |
| H      | L     | X     | X | X | L         | H  |
| L      | L     | X     | X | X | L*        | L* |
| H      | H     | ~     | L | L | No Change |    |
| H      | H     | ~     | L | H | L         | H  |
| H      | H     | ~     | H | L | H         | L  |
| H      | H     | ~     | H | H | Toggle    |    |
| H      | H     | L     | X | X | No Change |    |
| H      | H     | H     | X | X | No Change |    |
| H      | H     | ~     | X | X | No Change |    |

\*Both outputs will remain low as long as Set and Reset are low, but the output states are unpredictable if Set and Reset go high simultaneously.

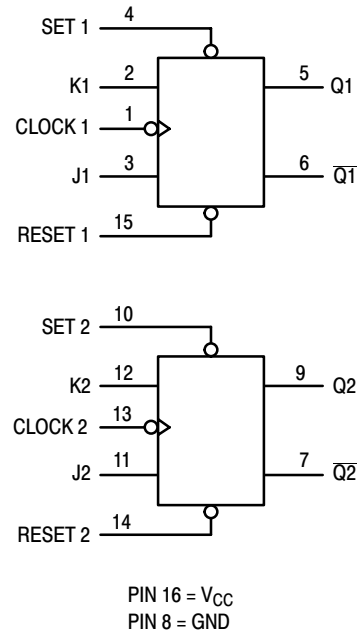


Figure 2. Logic Diagram

## ORDERING INFORMATION

| Device          | Package                | Shipping†         |
|-----------------|------------------------|-------------------|
| MC74HC112ANG    | PDIP-16<br>(Pb-Free)   | 500 Units / Rail  |
| MC74HC112ADG    | SOIC-16<br>(Pb-Free)   | 48 Units / Rail   |
| MC74HC112ADR2G  | SOIC-16<br>(Pb-Free)   | 2500 Units / Reel |
| MC74HC112ADTR2G | TSSOP-16*              | 2500 Units / Reel |
| MC74HC112AFELG  | SOEIAJ-16<br>(Pb-Free) | 2000 Units / Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*This package is inherently Pb-Free.

# MC74HC112A

## MAXIMUM RATINGS\*

| Symbol    | Parameter  | Value   | Unit              |    |
|-----------|--|---|-------------------|----|
| $V_{CC}$  | DC Supply Voltage (Referenced to GND)  | - 0.5 to + 7.0                                  | V                 |    |
| $V_{in}$  | DC Input Voltage (Referenced to GND)   | - 1.5 to $V_{CC} + 1.5$                         | V                 |    |
| $V_{out}$ | DC Output Voltage (Referenced to GND)  | - 0.5 to $V_{CC} + 0.5$                         | V                 |    |
| $I_{in}$  | DC Input Current, per Pin  | $\pm 20$  | mA                |    |
| $I_{out}$ | DC Output Current, per Pin   | $\pm 25$  | mA                |    |
| $I_{CC}$  | DC Supply Current, $V_{CC}$ and GND Pins                                     | $\pm 50$  | mA                |    |
| $P_D$     | Power Dissipation in Still Air   | Plastic DIP†<br>SOIC Package†<br>TSSOP Package† | 750<br>500<br>450 | mW |
| $T_{stg}$ | Storage Temperature  | - 65 to + 150                                   | °C                |    |
| $T_L$     | Lead Temperature, 1 mm from Case for 10 Seconds (Plastic DIP, SOIC or TSSOP) | 260   | °C                |    |

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation,  $V_{in}$  and  $V_{out}$  should be constrained to the range  $GND \leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$ . Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or  $V_{CC}$ ). Unused outputs must be left open.

\*Maximum Ratings are those values beyond which damage to the device may occur.

Functional operation should be restricted to the Recommended Operating Conditions.

†Derating — Plastic DIP: - 10 mW/°C from 65° to 125°C  
SOIC Package: - 7 mW/°C from 65° to 125°C  
TSSOP Package: - 6.1 mW/°C from 65° to 125°C

## RECOMMENDED OPERATING CONDITIONS

| Symbol            | Parameter  | Min  | Max         | Unit               |    |
|-------------------|--|--|-------------|--------------------|----|
| $V_{CC}$          | DC Supply Voltage (Referenced to GND)                | 2.0  | 6.0         | V                  |    |
| $V_{in}, V_{out}$ | DC Input Voltage, Output Voltage (Referenced to GND) | 0  | $V_{CC}$    | V                  |    |
| $T_A$             | Operating Temperature, All Package Types             | - 55   | + 125       | °C                 |    |
| $t_r, t_f$        | Input Rise and Fall Time (Figure 1)                  | $V_{CC} = 2.0 \text{ V}$<br>$V_{CC} = 4.5 \text{ V}$<br>$V_{CC} = 6.0 \text{ V}$ | 0<br>0<br>0 | 1000<br>500<br>400 | ns |

## DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

| Symbol   | Parameter                                      | Test Conditions  | $V_{CC}$<br>V | Guaranteed Limit |                         |                          | Unit          |
|----------|--|--|---------------|------------------|-------------------------|--------------------------|---------------|
|          |  |  |               | - 55 to<br>25°C  | $\leq 85^\circ\text{C}$ | $\leq 125^\circ\text{C}$ |               |
| $V_{IH}$ | Minimum High-Level Input Voltage               | $V_{out} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V}$<br>$ I_{out}  \leq 20 \mu\text{A}$                    | 2.0           | 1.5              | 1.5                     | 1.5                      | V             |
|          |  |  | 4.5           | 3.15             | 3.15                    | 3.15                     |               |
|          |  |  | 6.0           | 4.2              | 4.2                     | 4.2                      |               |
| $V_{IL}$ | Maximum Low-Level Input Voltage                | $V_{out} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V}$<br>$ I_{out}  \leq 20 \mu\text{A}$                    | 2.0           | 0.3              | 0.3                     | 0.3                      | V             |
|          |  |  | 4.5           | 0.9              | 0.9                     | 0.9                      |               |
|          |  |  | 6.0           | 1.2              | 1.2                     | 1.2                      |               |
| $V_{OH}$ | Minimum High-Level Output Voltage              | $V_{in} = V_{IH} \text{ or } V_{IL}$<br>$ I_{out}  \leq 20 \mu\text{A}$                                    | 2.0           | 1.9              | 1.9                     | 1.9                      | V             |
|          |  |  | 4.5           | 4.4              | 4.4                     | 4.4                      |               |
|          |  | $V_{in} = V_{IH} \text{ or } V_{IL}$<br>$ I_{out}  \leq 4.0 \text{ mA}$<br>$ I_{out}  \leq 5.2 \text{ mA}$ | 4.5           | 3.98             | 3.84                    | 3.70                     |               |
|          |  |  | 6.0           | 5.48             | 5.34                    | 5.20                     |               |
| $V_{OL}$ | Maximum Low-Level Output Voltage               | $V_{in} = V_{IH} \text{ or } V_{IL}$<br>$ I_{out}  \leq 20 \mu\text{A}$                                    | 2.0           | 0.1              | 0.1                     | 0.1                      | V             |
|          |  |  | 4.5           | 0.1              | 0.1                     | 0.1                      |               |
|          |  | $V_{in} = V_{IH} \text{ or } V_{IL}$<br>$ I_{out}  \leq 4.0 \text{ mA}$<br>$ I_{out}  \leq 5.2 \text{ mA}$ | 4.5           | 0.26             | 0.33                    | 0.40                     |               |
|          |  |  | 6.0           | 0.26             | 0.33                    | 0.40                     |               |
| $I_{in}$ | Maximum Input Leakage Current                  | $V_{in} = V_{CC} \text{ or GND}$   | 6.0           | $\pm 0.1$        | $\pm 1.0$               | $\pm 1.0$                | $\mu\text{A}$ |
| $I_{CC}$ | Maximum Quiescent Supply Current (per Package) | $V_{in} = V_{CC} \text{ or GND}$<br>$I_{out} = 0 \mu\text{A}$  | 6.0           | 4                | 40                      | 80                       | $\mu\text{A}$ |

# MC74HC112A

## AC ELECTRICAL CHARACTERISTICS (C<sub>L</sub> = 50 pF, Input t<sub>r</sub> = t<sub>f</sub> = 6 ns)

| Symbol                                 | Parameter   | V <sub>CC</sub><br>V | Guaranteed Limit |        |         | Unit |
|--|---|----------------------|------------------|--------|---------|------|
|  |   |                      | - 55 to<br>25°C  | ≤ 85°C | ≤ 125°C |      |
| f <sub>max</sub>                       | Maximum Clock Frequency (50% Duty Cycle)<br>(Figures 1 and 4)           | 2.0                  | 6.0              | 4.8    | 4.0     | MHz  |
|  |   | 4.5                  | 30               | 24     | 20      |      |
|  |   | 6.0                  | 35               | 28     | 24      |      |
| t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | Maximum Propagation Delay, Clock to Q or $\bar{Q}$<br>(Figures 1 and 4) | 2.0                  | 125              | 155    | 190     | ns   |
|  |   | 4.5                  | 25               | 31     | 38      |      |
|  |   | 6.0                  | 21               | 26     | 32      |      |
| t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | Maximum Propagation Delay, Reset to Q or $\bar{Q}$<br>(Figures 2 and 4) | 2.0                  | 155              | 195    | 235     | ns   |
|  |   | 4.5                  | 31               | 39     | 47      |      |
|  |   | 6.0                  | 26               | 33     | 40      |      |
| t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | Maximum Propagation Delay, Set to Q or $\bar{Q}$<br>(Figures 2 and 4)   | 2.0                  | 165              | 205    | 250     | ns   |
|  |   | 4.5                  | 33               | 41     | 50      |      |
|  |   | 6.0                  | 28               | 35     | 43      |      |
| t <sub>TLH</sub> ,<br>t <sub>THL</sub> | Maximum Output Transition Time, Any Output<br>(Figures 1 and 4)         | 2.0                  | 75               | 95     | 110     | ns   |
|  |   | 4.5                  | 15               | 19     | 22      |      |
|  |   | 6.0                  | 13               | 16     | 19      |      |
| C <sub>in</sub>                        | Maximum Input Capacitance   | —                    | 10               | 10     | 10      | pF   |

| C <sub>PD</sub> | Power Dissipation Capacitance (Per Flip-Flop)* | Typical @ 25°C, V <sub>CC</sub> = 5.0 V |  |  | pF |
|-----------------|--|---|--|--|----|
|                 |  | 35                                      |  |  |    |
|                 |  |   |  |  |    |

\* Used to determine the no-load dynamic power consumption:  $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$ .

## TIMING REQUIREMENTS (Input t<sub>r</sub> = t<sub>f</sub> = 6 ns)

| Symbol                          | Parameter   | V <sub>CC</sub><br>V | Guaranteed Limit |        |         | Unit |
|---------------------------------|---|----------------------|------------------|--------|---------|------|
|                                 |   |                      | - 55 to<br>25°C  | ≤ 85°C | ≤ 125°C |      |
| t <sub>su</sub>                 | Minimum Setup Time, J or K to Clock<br>(Figure 3)                   | 2.0                  | 100              | 125    | 150     | ns   |
|                                 |   | 4.5                  | 20               | 25     | 30      |      |
|                                 |   | 6.0                  | 17               | 21     | 26      |      |
| t <sub>h</sub>                  | Minimum Hold Time, Clock to J or K<br>(Figure 3)                    | 2.0                  | 3                | 3      | 3       | ns   |
|                                 |   | 4.5                  | 3                | 3      | 3       |      |
|                                 |   | 6.0                  | 3                | 3      | 3       |      |
| t <sub>rec</sub>                | Minimum Recovery Time, Set or Reset Inactive to Clock<br>(Figure 2) | 2.0                  | 100              | 125    | 150     | ns   |
|                                 |   | 4.5                  | 20               | 25     | 30      |      |
|                                 |   | 6.0                  | 17               | 21     | 26      |      |
| t <sub>w</sub>                  | Minimum Pulse Width, Clock<br>(Figure 1)                            | 2.0                  | 80               | 100    | 120     | ns   |
|                                 |   | 4.5                  | 16               | 20     | 24      |      |
|                                 |   | 6.0                  | 14               | 17     | 20      |      |
| t <sub>w</sub>                  | Minimum Pulse Width, Set or Reset<br>(Figure 2)                     | 2.0                  | 80               | 100    | 120     | ns   |
|                                 |   | 4.5                  | 16               | 20     | 24      |      |
|                                 |   | 6.0                  | 14               | 17     | 20      |      |
| t <sub>r</sub> , t <sub>f</sub> | Maximum Input Rise and Fall Times<br>(Figure 1)                     | 2.0                  | 1000             | 1000   | 1000    | ns   |
|                                 |   | 4.5                  | 500              | 500    | 500     |      |
|                                 |   | 6.0                  | 400              | 400    | 400     |      |

# MC74HC112A

## SWITCHING WAVEFORMS

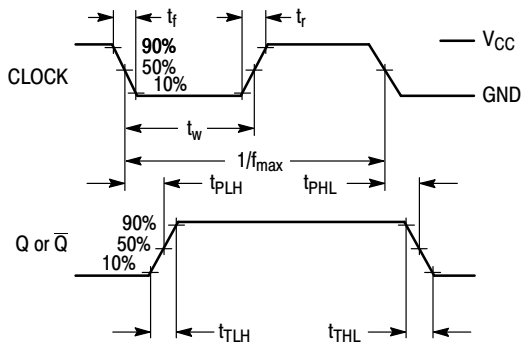


Figure 1.

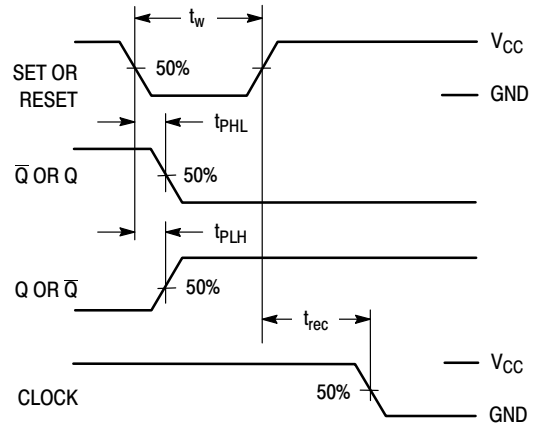


Figure 2.

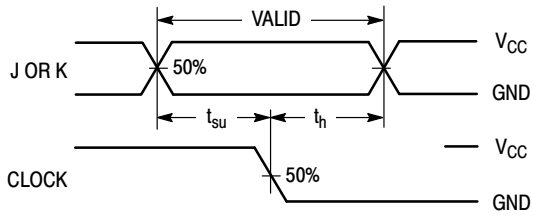
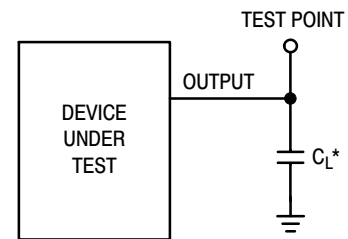


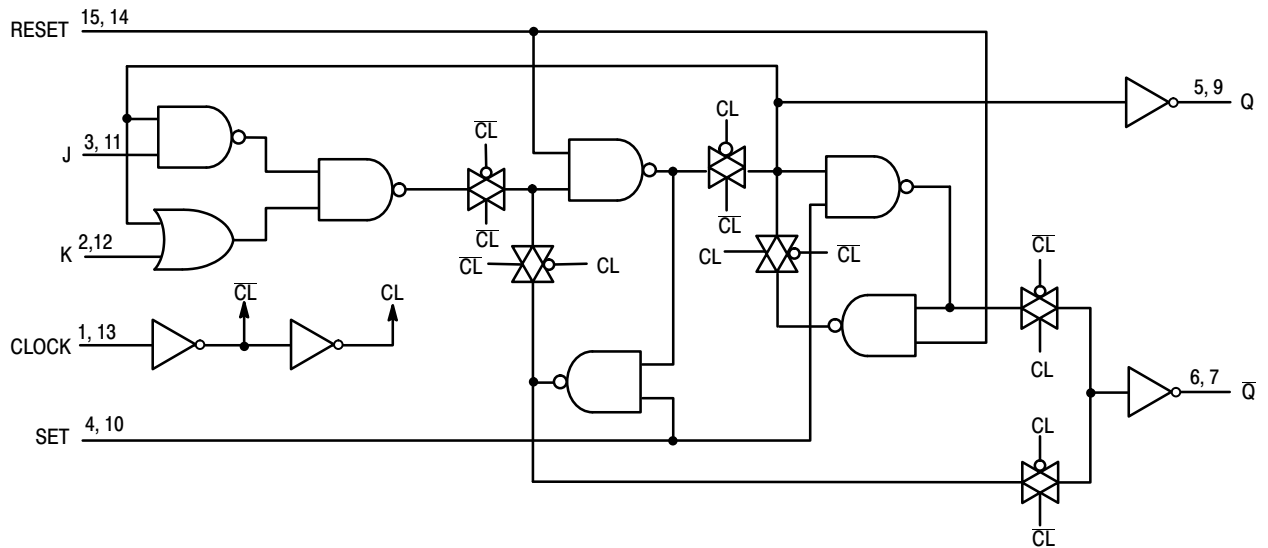
Figure 3.



\*Includes all probe and jig capacitance

Figure 4. Test Circuit

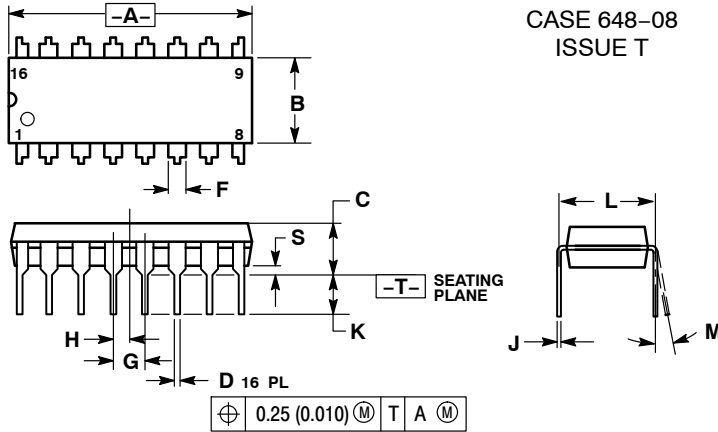
## EXPANDED LOGIC DIAGRAM



# MC74HC112A

## PACKAGE DIMENSIONS

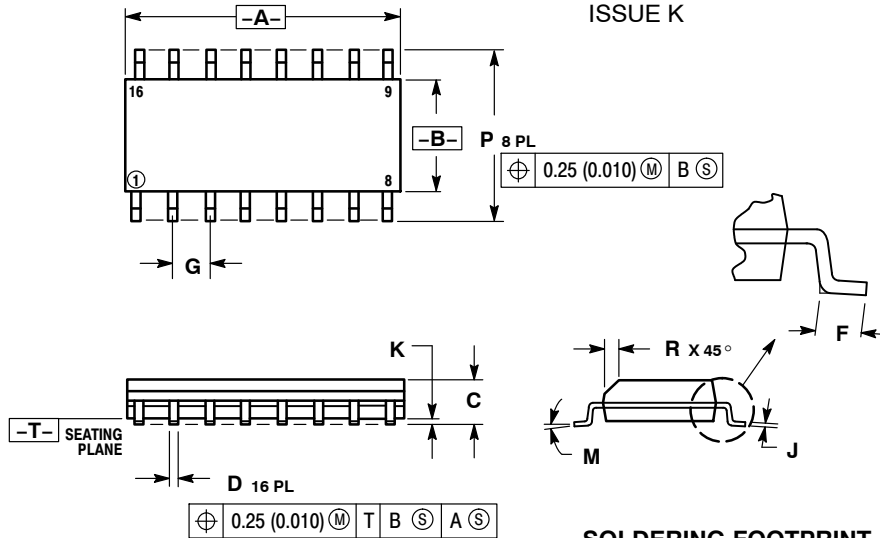
### PDIP-16 N SUFFIX CASE 648-08 ISSUE T



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
  4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
  5. ROUNDED CORNERS OPTIONAL.

| DIM | INCHES    |       | MILLIMETERS |       |
|-----|-----------|-------|-------------|-------|
|     | MIN       | MAX   | MIN         | MAX   |
| A   | 0.740     | 0.770 | 18.80       | 19.55 |
| B   | 0.250     | 0.270 | 6.35        | 6.85  |
| C   | 0.145     | 0.175 | 3.69        | 4.44  |
| D   | 0.015     | 0.021 | 0.39        | 0.53  |
| F   | 0.040     | 0.70  | 1.02        | 1.77  |
| G   | 0.100 BSC |       | 2.54 BSC    |       |
| H   | 0.050 BSC |       | 1.27 BSC    |       |
| J   | 0.008     | 0.015 | 0.21        | 0.38  |
| K   | 0.110     | 0.130 | 2.80        | 3.30  |
| L   | 0.295     | 0.305 | 7.50        | 7.74  |
| M   | 0°        | 10°   | 0°          | 10°   |
| S   | 0.020     | 0.040 | 0.51        | 1.01  |

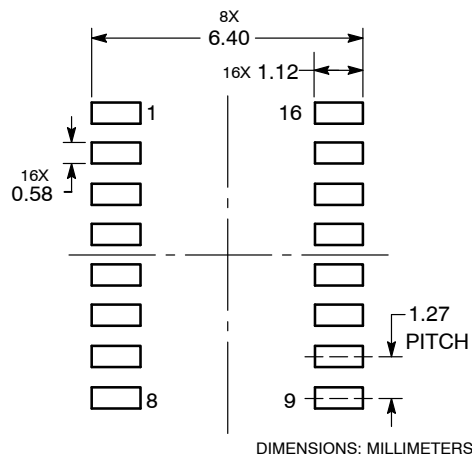
### SOIC-16 D SUFFIX CASE 751B-05 ISSUE K



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
  4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
  5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

| DIM | MILLIMETERS |       | INCHES    |       |
|-----|-------------|-------|-----------|-------|
|     | MIN         | MAX   | MIN       | MAX   |
| A   | 9.80        | 10.00 | 0.386     | 0.393 |
| B   | 3.80        | 4.00  | 0.150     | 0.157 |
| C   | 1.35        | 1.75  | 0.054     | 0.068 |
| D   | 0.35        | 0.49  | 0.014     | 0.019 |
| F   | 0.40        | 1.25  | 0.016     | 0.049 |
| G   | 1.27 BSC    |       | 0.050 BSC |       |
| J   | 0.19        | 0.25  | 0.008     | 0.009 |
| K   | 0.10        | 0.25  | 0.004     | 0.009 |
| M   | 0°          | 7°    | 0°        | 7°    |
| P   | 5.80        | 6.20  | 0.229     | 0.244 |
| R   | 0.25        | 0.50  | 0.010     | 0.019 |

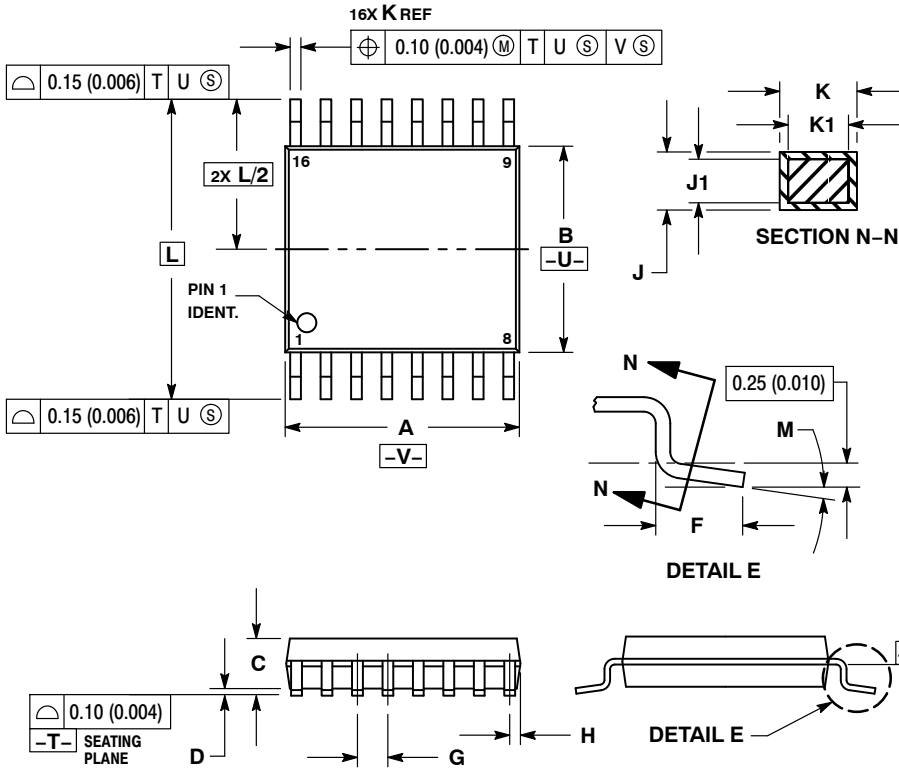
### SOLDERING FOOTPRINT



# MC74HC112A

## PACKAGE DIMENSIONS

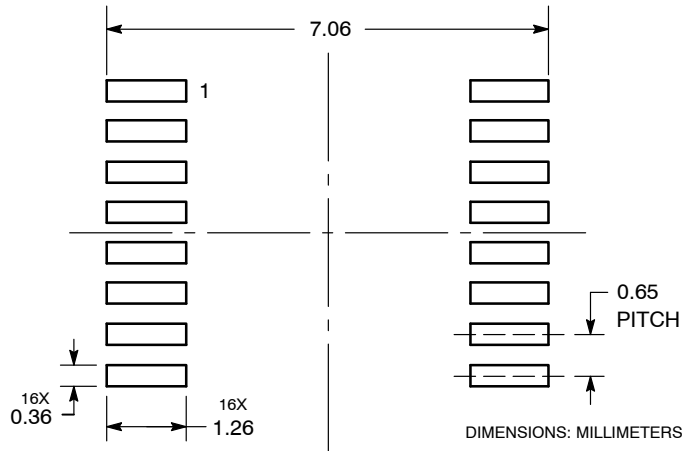
TSSOP-16  
DT SUFFIX  
CASE 948F-01  
ISSUE B



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
  4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
  5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
  6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
  7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

| DIM | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
|     | MIN         | MAX  | MIN       | MAX   |
| A   | 4.90        | 5.10 | 0.193     | 0.200 |
| B   | 4.30        | 4.50 | 0.169     | 0.177 |
| C   | ---         | 1.20 | ---       | 0.047 |
| D   | 0.05        | 0.15 | 0.002     | 0.006 |
| F   | 0.50        | 0.75 | 0.020     | 0.030 |
| G   | 0.65 BSC    |      | 0.026 BSC |       |
| H   | 0.18        | 0.28 | 0.007     | 0.011 |
| J   | 0.09        | 0.20 | 0.004     | 0.008 |
| J1  | 0.09        | 0.16 | 0.004     | 0.006 |
| K   | 0.19        | 0.30 | 0.007     | 0.012 |
| K1  | 0.19        | 0.25 | 0.007     | 0.010 |
| L   | 6.40 BSC    |      | 0.252 BSC |       |
| M   | 0°          | 8°   | 0°        | 8°    |

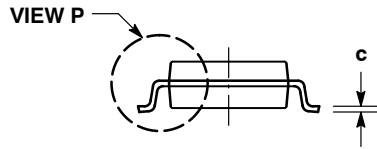
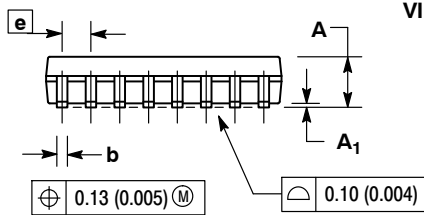
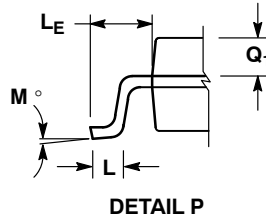
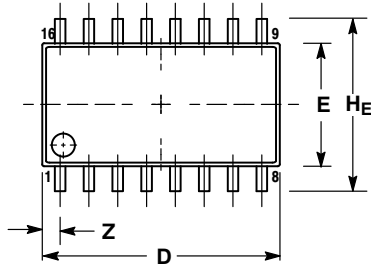
### SOLDERING FOOTPRINT



# MC74HC112A

## PACKAGE DIMENSIONS

SOEIAJ-16  
F SUFFIX  
CASE 966-01  
ISSUE A



**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

| DIM            | MILLIMETERS |       | INCHES    |       |
|----------------|-------------|-------|-----------|-------|
|                | MIN         | MAX   | MIN       | MAX   |
| A              | ---         | 2.05  | ---       | 0.081 |
| A <sub>1</sub> | 0.05        | 0.20  | 0.002     | 0.008 |
| b              | 0.35        | 0.50  | 0.014     | 0.020 |
| c              | 0.10        | 0.20  | 0.007     | 0.011 |
| D              | 9.90        | 10.50 | 0.390     | 0.413 |
| E              | 5.10        | 5.45  | 0.201     | 0.215 |
| e              | 1.27 BSC    |       | 0.050 BSC |       |
| H <sub>E</sub> | 7.40        | 8.20  | 0.291     | 0.323 |
| L              | 0.50        | 0.85  | 0.020     | 0.033 |
| L <sub>E</sub> | 1.10        | 1.50  | 0.043     | 0.059 |
| M              | 0°          | 10°   | 0°        | 10°   |
| Q <sub>1</sub> | 0.70        | 0.90  | 0.028     | 0.035 |
| Z              | ---         | 0.78  | ---       | 0.031 |

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